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# FSA4157, FSA4157A

## Low-Voltage, 1 Ω SPDT Analog Switch

### Features

- FSA4157A Features Lower  $I_{CC}$  when the S Input is Lower Than  $V_{CC}$
- Maximum 1.15 Ω On Resistance ( $R_{ON}$ ) at 4.5 V  $V_{CC}$
- 0.3 Ω Maximum  $R_{ON}$  Flatness at 4.5 V  $V_{CC}$
- Space-Saving 6-lead, MicroPak™ and SC70 6 Packages
- Broad  $V_{CC}$  Operating Range:
  - FSA4157: 1.65 V to 5.5 V
  - FSA4157A: 2.7 V to 5.5 V
- Fast Turn-On and Turn-Off Time
- Break-Before-Make Enable Circuitry
- Over-Voltage Tolerant TTL-Compatible Control Circuitry

### Description

FSA4157 and FSA4157A are high performance Single Pole/Double Throw (SPDT) analog switches. Both devices feature ultra low  $R_{ON}$  of 1.15 Ω maximum at 4.5 V  $V_{CC}$  and operates over the wide  $V_{CC}$  range of 1.65 V to 5.5 V for FSA4157, and 2.7 V to 5.5 V for FSA4157A. The device is fabricated with sub-micron CMOS technology to achieve fast switching speeds and is designed for break-before-make operation. The select input is TTL level compatible.

The FSA4157A features very low quiescent current even when the control voltage is lower than the  $V_{CC}$  supply. This feature services the mobile handset applications very well allowing for the direct interface with baseband processor general purpose I/Os.

### Ordering Information

Part Number	Top Mark	Package Description	Packing Method
FSA4157P6X	A57	6-Lead SC70, EIAJ SC88, 1.25 mm Wide	3000 Units Tape and Reel
FSA4157L6X	EG	6-Lead MicroPak,™ 1.0 mm Wide	5000 Units Tape and Reel
FSA4157AP6X	B57	6-Lead SC70, EIAJ SC88, 1.25 mm Wide	3000 Units Tape and Reel
FSA4157AL6X	EU	6-Lead MicroPak™, 1.0 mm Wide	5000 Units Tape and Reel

## Pin Configurations

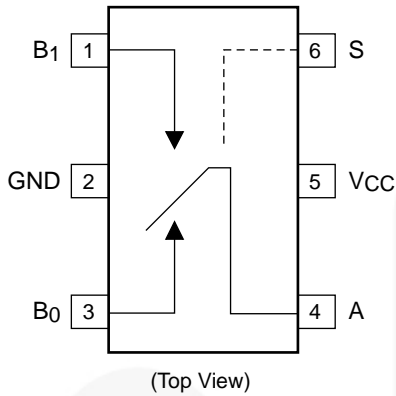


Figure 1. SC70 Pin Assignments

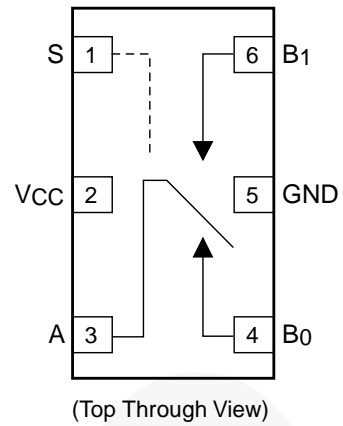


Figure 2. MicroPak™ Pin Assignments

## Pin Definitions

Pin# SC70	Pin# MicroPak™	Name	Description
1	6	B1	Data Ports
2	5	GND	Ground
3	4	B0	Data Ports
4	3	A	Data Ports
5	2	V <sub>CC</sub>	Supply Voltage
6	1	S	Control Input

## Truth Table

Control Input (S)	Function
Low	B0 connected to A
High	B1 connected to A

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage		-0.5	6.0	V
V <sub>S</sub>	DC Switch Voltage <sup>(1)</sup>		-0.5	V <sub>CC</sub> + 0.5	V
V <sub>IN</sub>	DC Input Voltage <sup>(1)</sup>		-0.5	6.0	V
I <sub>IK</sub>	DC Input Diode Current		-50		mA
I <sub>SW</sub>	Switch Current			200	mA
I <sub>SWPEAK</sub>	Peak Switch Current (Pulse at 1 ms duration, <10% Duty Cycle)			400	mA
P <sub>D</sub>	Power Dissipation at 85°C	SC70		180	mW
		MicroPak™			
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
T <sub>J</sub>	Maximum Junction Temperature			+150	°C
T <sub>L</sub>	Lead Temperature (Soldering, 10 seconds)			+260	°C
ESD	Electrostatic Discharge Capability	Human Body Model, JESD22-A114 (FSA4157A)		7500	V

**Note:**

- Input and output negative ratings may be exceeded if input and output diode current ratings are observed.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter		Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage	FSA4157	1.65	5.50	V
		FSA4157A	2.7	5.5	
V <sub>CNTRL</sub>	Control Input Voltage <sup>(2)</sup>		0	V <sub>CC</sub>	V
V <sub>SW</sub>	Switch Input Voltage		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
θ <sub>JA</sub>	Thermal Resistance in Still Air	SC70		350	°C/W
		MicroPak™ (Estimated)		330	

**Note:**

- Control input must be held HIGH or LOW and it must not float.

## DC Electrical Characteristics

Typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Ambient Temperature					Unit
				-25°			-40 to +85°C		
				Min.	Typ.	Max.	Min.	Max.	
V <sub>IH</sub>	Input Voltage High	FSA4157 Only	1.8 to 2.7				1.0		V
			2.7 to 3.6				2.0		
			4.5 to 5.5				2.4		
V <sub>IL</sub>	Input Voltage Low	FSA4157 Only	1.8 to 2.7					0.4	V
		FSA4157A Only	2.7 to 3.6					0.4	
			2.7 to 3.6					0.6	
			4.5 to 5.5					0.8	
I <sub>IN</sub>	Control Input Leakage	V <sub>IN</sub> =0 V to V <sub>CC</sub>	2.7 to 3.6				-1.0	1.0	μA
			4.5 to 5.5				-1.0	1.0	
I <sub>NO(OFF)</sub> , I <sub>NC(OFF)</sub>	Off Leakage Current of Port B0 and B1	A=1 V, 4.5 V, B <sub>0</sub> or B <sub>1</sub> =4.5, 1 V	5.5		±2		-20	20	nA
I <sub>A(ON)</sub>	On Leakage Current of Port A	A=1 V, 4.5V, B <sub>0</sub> or B <sub>1</sub> =4.5, 1 V, 4.5 V or Floating	5.5		±4		-40	40	nA
R <sub>ON</sub>	Switch On Resistance	I <sub>OUT</sub> =100 mA, B <sub>0</sub> or B <sub>1</sub> =1.5 V	2.7		2.6	4.0		4.3	Ω
		I <sub>OUT</sub> =100mA, B <sub>0</sub> or B <sub>1</sub> =3.5V	4.5		0.95	1.15		1.30	
ΔR <sub>ON</sub>	On Resistance Matching Between Channels <sup>(4)</sup>	I <sub>OUT</sub> =100 mA, B <sub>0</sub> or B <sub>1</sub> =1.5 V	4.5		0.06	0.12		0.15	Ω
R <sub>FLAT(ON)</sub>	On Resistance Flatness <sup>(4)</sup>	I <sub>OUT</sub> =100 mA, B <sub>0</sub> or B <sub>1</sub> =0 V, 0.75 V, 1.5 V	2.7		1.4				Ω
		I <sub>OUT</sub> =100 mA, B <sub>0</sub> or B <sub>1</sub> =0 V, 1 V, 2 V	4.5		0.2	0.3		0.4	
I <sub>CC</sub>	Quiescent Supply Current	V <sub>IN</sub> =0 V or V <sub>CC</sub> , I <sub>OUT</sub> =0 V	3.6		0.1	0.5		1.0	μA
			5.5		0.1	0.5		1.0	
ΔI <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	One Input at 2.7 V, others at V <sub>CC</sub> or GND (FSA4157A Only)	4.3		0.2			10.0	μA

### Notes:

- Measured by the voltage drop between the A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the two (A or B ports).
- ΔR<sub>ON</sub> = R<sub>ON max</sub> – R<sub>ON min</sub> measured at identical V<sub>CC</sub>, temperature, and voltage.
- Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions.

## AC Electrical Characteristics

Typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Ambient Temperature					Unit	Figure
				-25°			-40 to +85°C			
				Min.	Typ.	Max.	Min.	Max.		
t <sub>ON</sub>	Turn-On Time	B <sub>0</sub> or B <sub>1</sub> =1.5 V, R <sub>L</sub> =50 Ω, C <sub>L</sub> =35 pF (FSA4157A Only)	2.7 to 3.6			60		65	ns	Figure 8
		B <sub>0</sub> or B <sub>1</sub> =1.5 V, R <sub>L</sub> =50Ω, C <sub>L</sub> =35pF	2.7 to 3.6			50		60		
		B <sub>0</sub> or B <sub>1</sub> =1.5 V, R <sub>L</sub> =50 Ω, C <sub>L</sub> =35pF	4.5 to 5.5			35		40		
t <sub>OFF</sub>	Turn-Off Time	B <sub>0</sub> or B <sub>1</sub> =1.5 V, R <sub>L</sub> =50 Ω, C <sub>L</sub> =35 pF	2.7 to 3.6			20		30	ns	Figure 8
		B <sub>0</sub> or B <sub>1</sub> =1.5 V, R <sub>L</sub> =50 Ω, C <sub>L</sub> =35 pF	4.5 to 5.5			15		20		
t <sub>BBM</sub>	Break-Before-Make Time	FSA4157	2.7 to 3.6						ns	Figure 9
			4.5 to 5.5		20					
		FSA4157A Only	4.5 to 5.5		25					
Q	Charge Injection	C <sub>L</sub> =1.0 nF, V <sub>GE</sub> =0 V, R <sub>GEN</sub> =0 Ω	2.7 to 3.6		10			pC	Figure 11	
			4.5 to 5.5		20					
OIRR	Off Isolation	f=1 MHz, R <sub>L</sub> =50 Ω	2.7 to 3.6		-70			dB	Figure 10	
			4.5 to 5.5		-70					
Xtalk	Crosstalk	f=1 MHz, R <sub>L</sub> =50 Ω	2.7 to 3.6		-70			dB	Figure 10	
			4.5 to 5.5		-70					
BW	-3db Bandwidth	R <sub>L</sub> =50 Ω	2.7 to 3.6			300		MHz	Figure 13	
			4.5 to 5.5			300				
THD	Total Harmonic Distortion	R <sub>L</sub> =600 Ω, V <sub>IN</sub> =0.5, f=20 Hz to 20 kHz	2.7 to 3.6		0.002			%	Figure 14	
			4.5 to 5.5		0.002					

## Capacitance

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Ambient Temperature			Unit	Figure
				-25°				
				Min.	Typ.	Max.		
C <sub>IN</sub>	Control Pin Input Capacitance	f=1 MHz	0		3.5		pF	Figure 12
C <sub>OFF</sub>	B Port Off Capacitance	f=1 MHz	4.5		12.0		pF	Figure 12
C <sub>ON</sub>	On Capacitance	f=1 MHz	4.5		40.0		pF	Figure 12

Typical Performance Characteristics

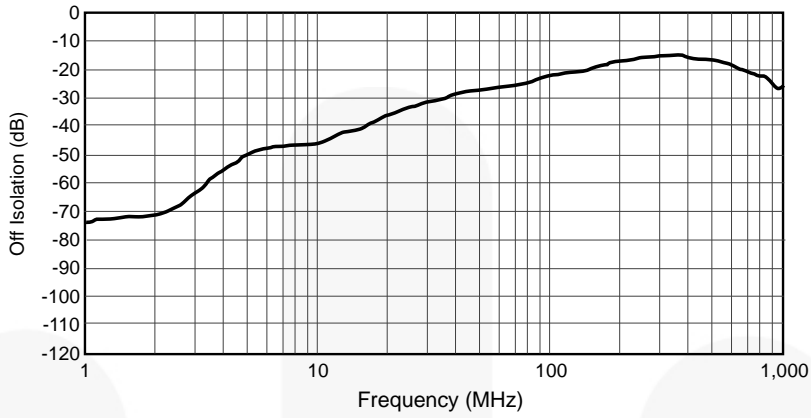


Figure 3. Off Isolation,  $V_{CC} = 2.7\text{ V to }5.5\text{ V}$

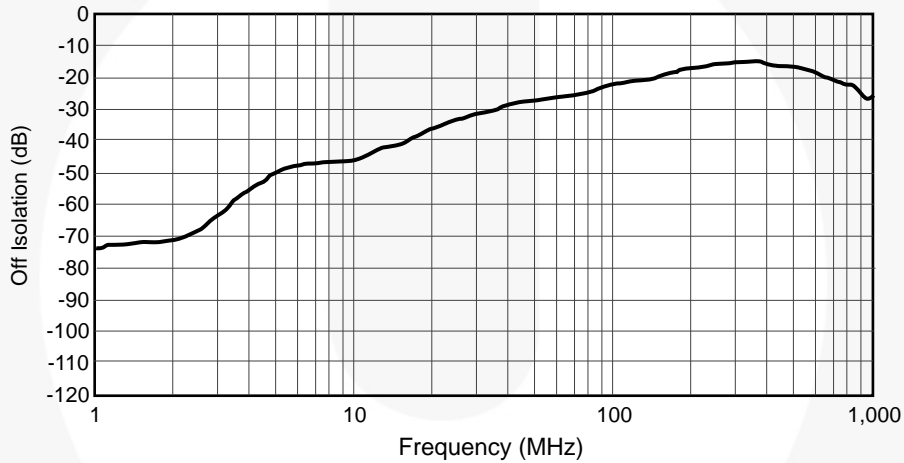


Figure 4. Crosstalk,  $V_{CC} = 2.7\text{ V to }5.5\text{ V}$

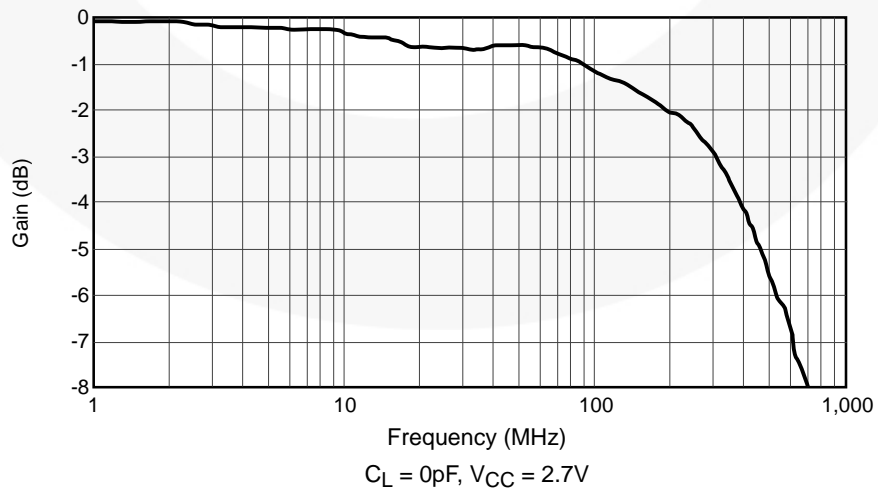
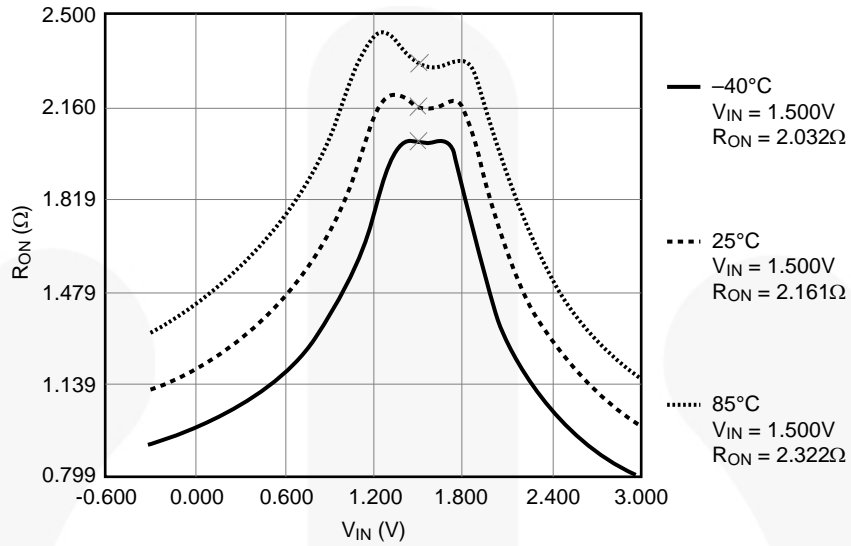
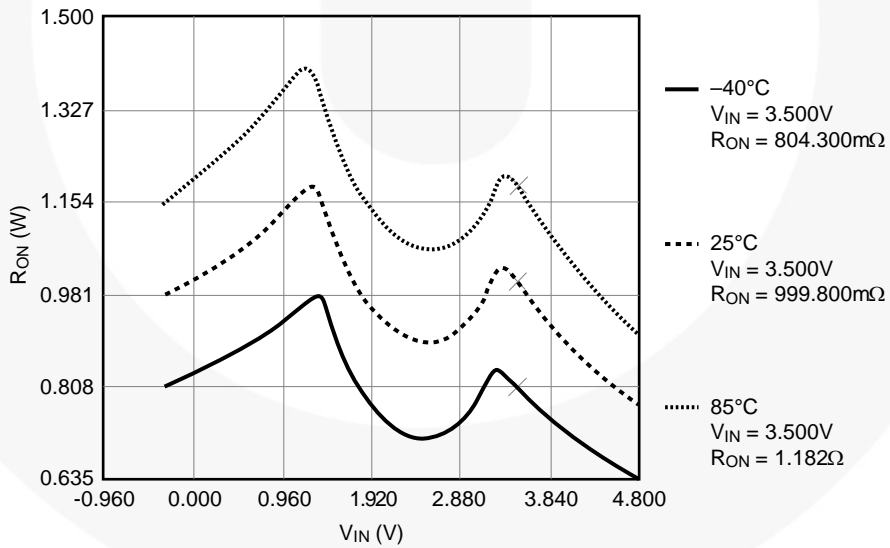


Figure 5. Bandwidth,  $V_{CC} = 2.7\text{ V to }5.5\text{ V}$

**Typical Performance Characteristics** (Continued)



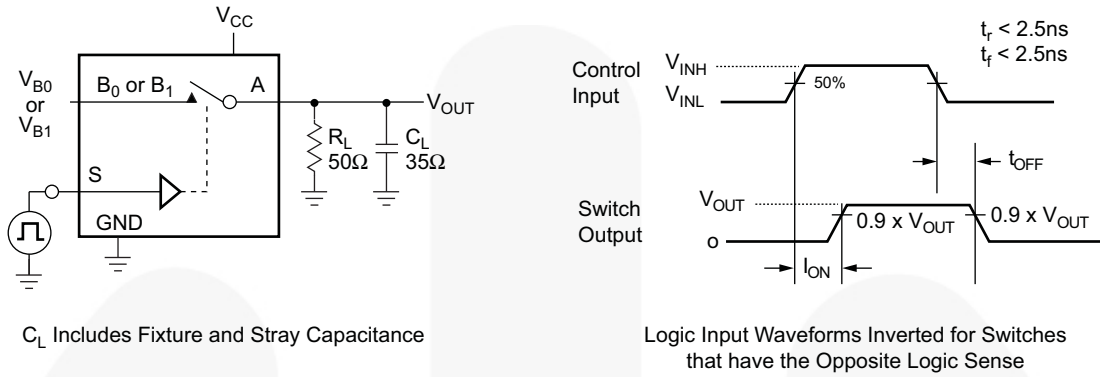
**Figure 6. R<sub>ON</sub> Switch On Resistance, I<sub>ON</sub> = 100 mA, V<sub>CC</sub> = 2.7**



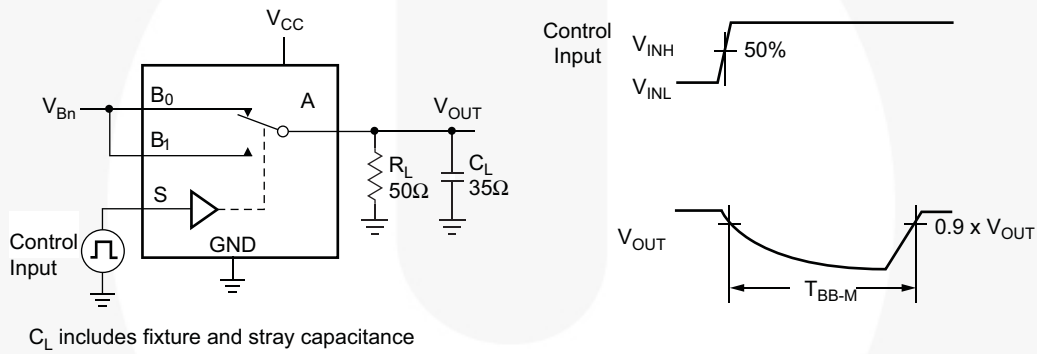
**Figure 7. R<sub>ON</sub> Switch On Resistance, I<sub>ON</sub> = 100 mA, V<sub>CC</sub> = 4.5 V**



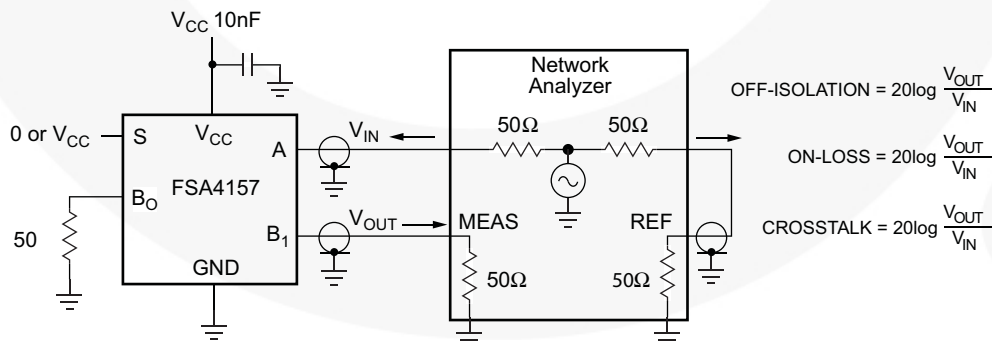
## AC Loadings and Waveforms



**Figure 8. Turn On / Off Timing**

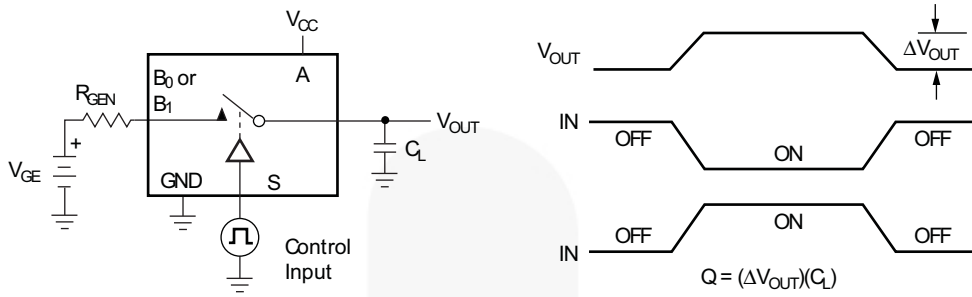


**Figure 9. Break Before Make Timing**

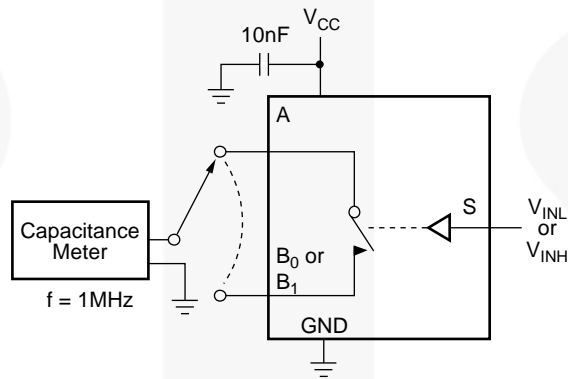


**Figure 10. Off Isolation and Crosstalk**

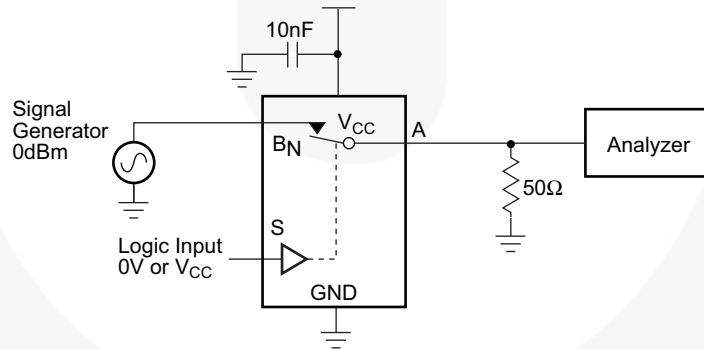
**AC Loadings and Waveforms (Continued)**



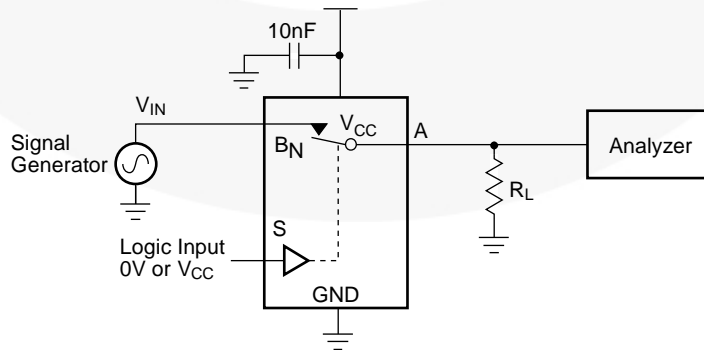
**Figure 11. Charge Injection**



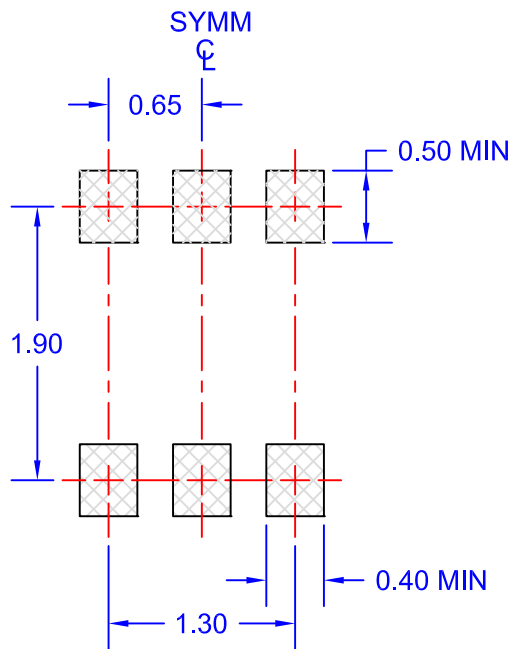
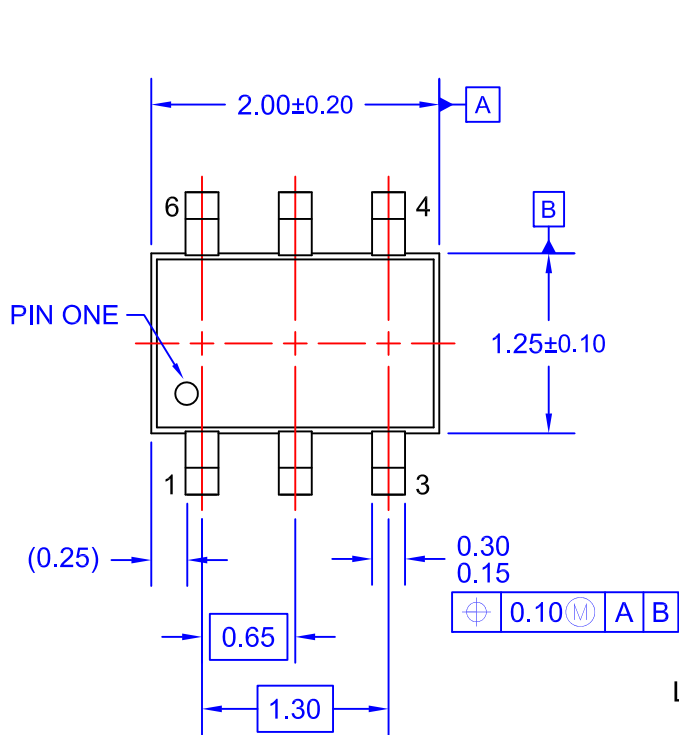
**Figure 12. On / Off Capacitance Measurement Setup**



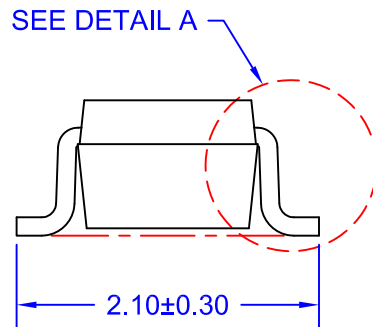
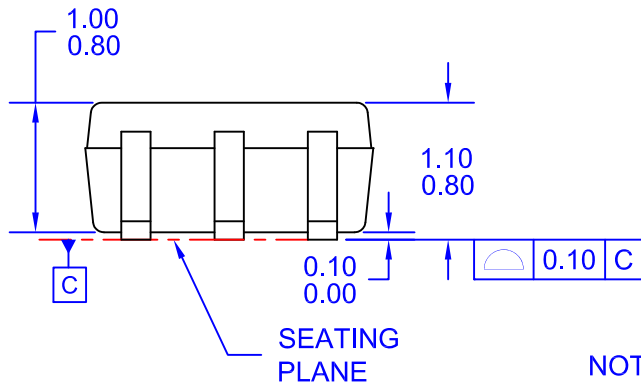
**Figure 13. Bandwidth**



**Figure 14. Harmonic Distortion**



LAND PATTERN RECOMMENDATION

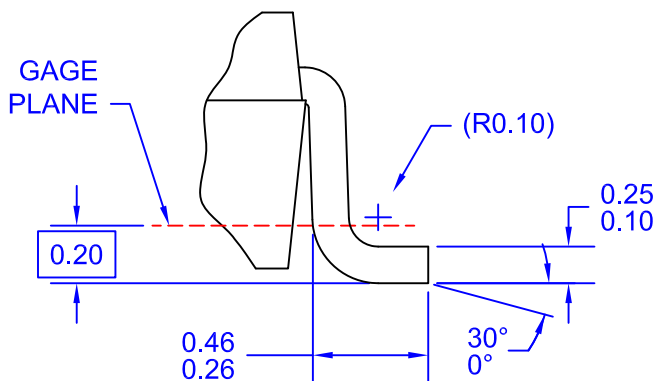


NOTES: UNLESS OTHERWISE SPECIFIED  
 A) THIS PACKAGE CONFORMS TO EIAJ SC-88, 1996.

B) ALL DIMENSIONS ARE IN MILLIMETERS.  
 C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.

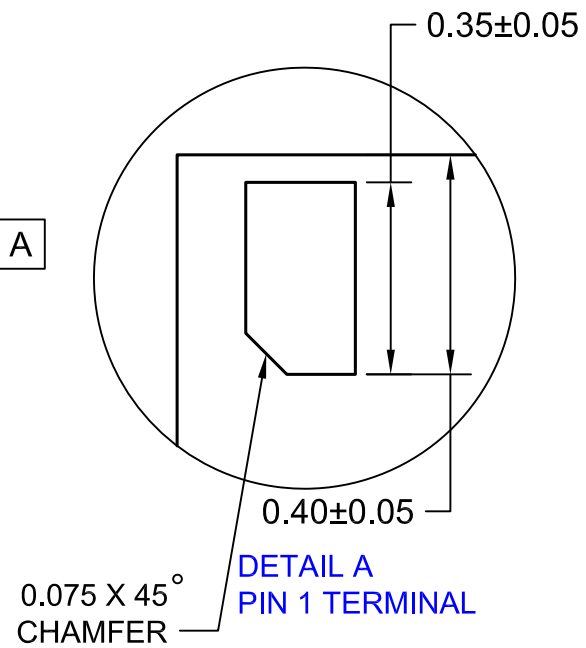
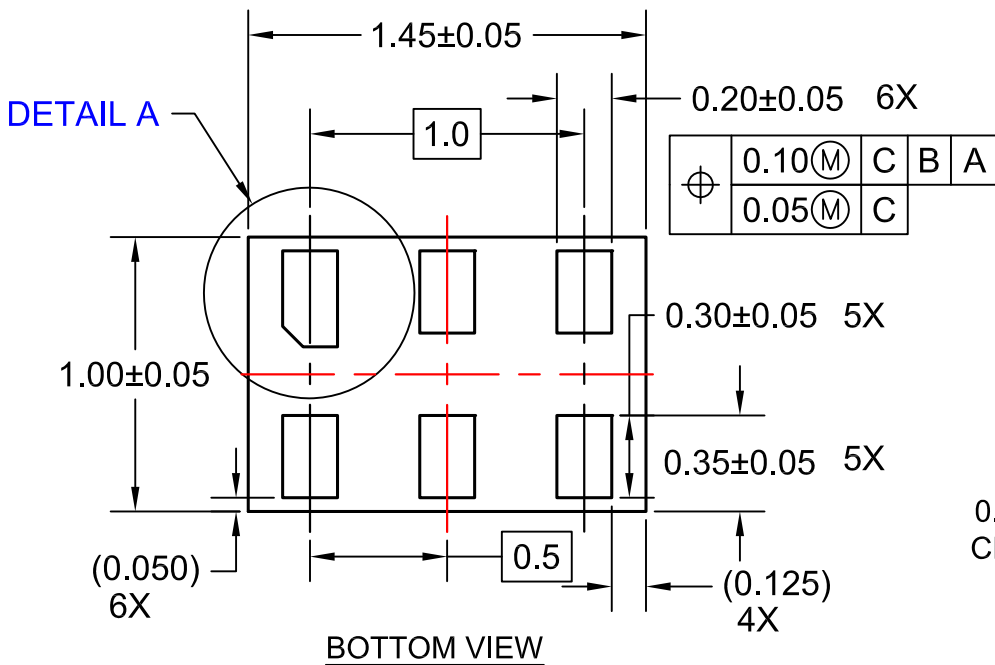
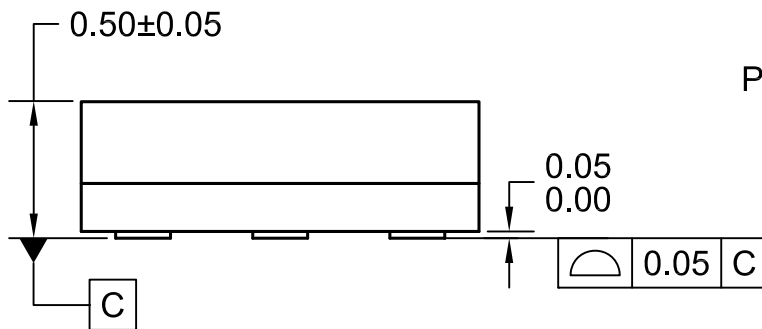
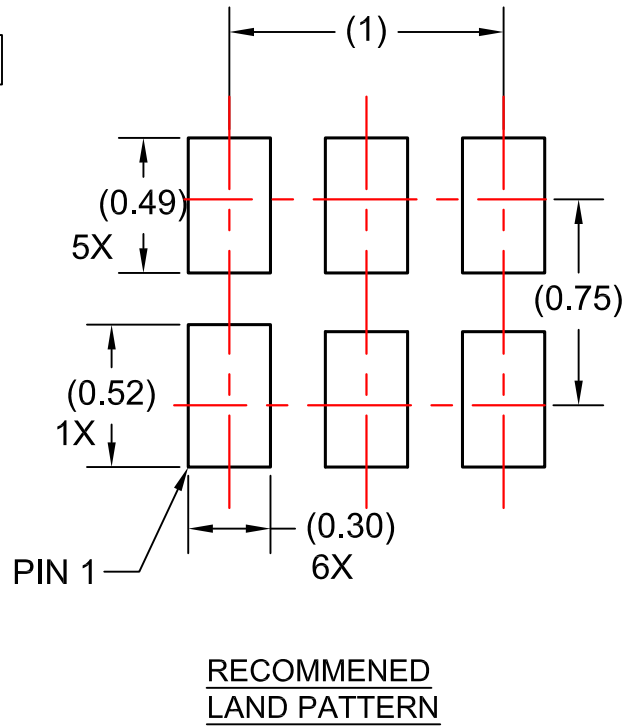
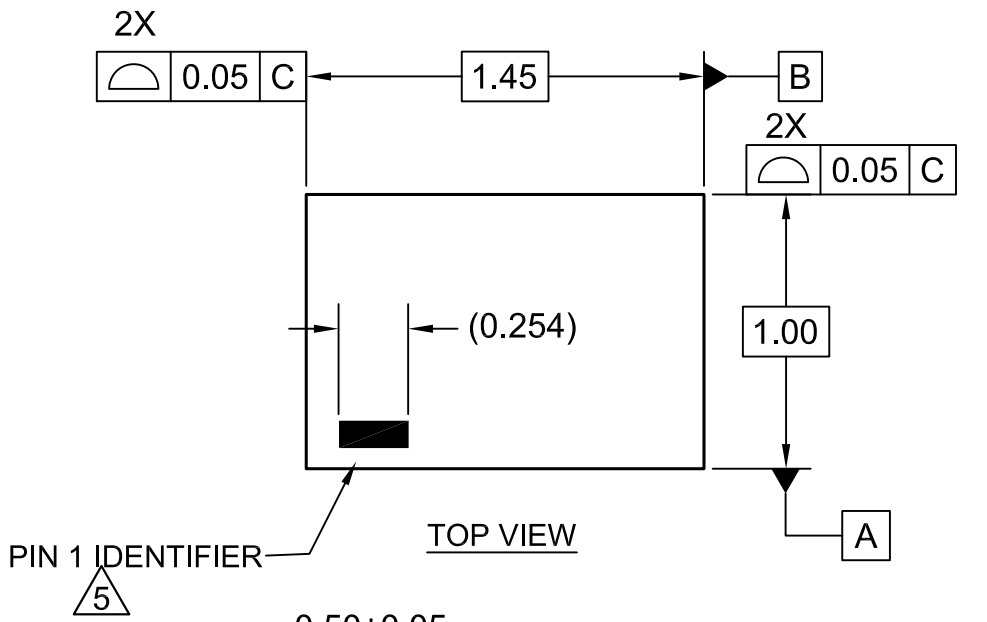
D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009

E) DRAWING FILENAME: MKT-MAA06AREV7



DETAIL A  
 SCALE: 60X





NOTES:

1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-2009
4. LANDPATTERN RECOMMENDATION PER FSC
5. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.
6. FILENAME AND REVISION: MAC06AREV6





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Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

**PRODUCT STATUS DEFINITIONS**

**Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.